

AGM732F-COM 1.25Gbps SFP Optical Transceiver, 20km Reach

Features

- Dual data-rate of 1.25Gbps/1.063Gbps operation
- 1310nm FP laser and PIN photodetector for 20km transmission
- Compliant with SFP MSA and SFF-8472 with duplex LC receptacle
- Digital Diagnostic Monitoring:
- Internal Calibration or External Calibration
- Compatible with SONET OC-24-LR-1
- Compatible with RoHS
- +3.3V single power supply
- Operating case temperature:
- Standard: 0 to +70°C
- Industrial: -40 to +85°C

Applications

- Gigabit Ethernet
- Fiber Channel
- Switch to Switch interface
- Switched backplane applications
- Router/Server interface
- Other optical transmission systems

Description

The SFP transceivers are high performance, cost effective modules supporting dual data-rate of 1.25Gbps/1.0625Gbps and 20km transmission distance with SMF.

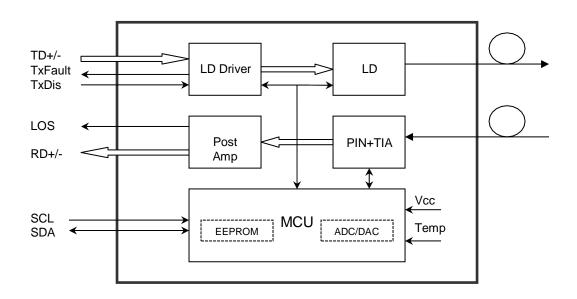
The transceiver consists of three sections: a FP laser transmitter, a PIN photodiode integrated with a trans-impedance preamplifier (TIA) and MCU control unit. All modules satisfy class I laser safety requirements.

The transceivers are compatible with SFP Multi-Source Agreement (MSA) and SFF-8472. For further information, please refer to SFP MSA.

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1000BASE-LX SFP 1310nm,SMF,20km, LC Dúplex, DOM for Cisco



Absolute Maximum Ratings

Table 1 - Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit
Supply Voltage	Vcc	-0.5	4.5	V
Storage Temperature	Ts	-40	+85	°C
Operating Humidity	-	5	85	%

Recommended Operating Conditions

Table 2 - Recommended Operating Conditions

	Par	ameter	Symbol	Min	Typical	Max	Unit
Operat	ting	Standard	_	0		+70	°C
Case Tempe	rature	Industrial	Тс	-40		+85	°C
Pc	Power Supply Voltage		Vcc	3.13	3.3	3.47	V
Pc	Power Supply Current		Icc			300	mA
	Giga	abit Ethernet			1.25		Chas
	Fibe	er Channel			1.063		Gbps

Optical and Electrical Characteristics

AGM732F-COM: (FP and PIN, 1310nm, 20km Reach)

Table 3 - Optical and Electrical Characteristics

Parameter :	Symbol	Min	Typical	Max	Unit	Notes
		Tran	ısmitter			
Centre Wavelength	λc	1260	1310	1360	nm	
Spectral Width (RMS)	Δλ			4	nm	



Av	erage Output Power	Pout	-9		-3	dBm	1
Ex	tinction Ratio	ER	9			dB	
	otical Rise/Fall ne (20%~80%)	tr/tf			0.26	ns	
	ta Input Swing Differential	V _{IN}	400		1800	mV	2
	ut Differential Impedance	Z _{IN}	90	100	110	Ω	
TX	Disable		2.0		Vcc	V	
Disable	Enable		0		0.8	V	
TV Family	Fault		2.0		Vcc	V	
TX Fault	Normal		0		0.8	V	
			Re	ceiver			
Cen	tre Wavelength	λc	1260		1580	nm	
Rece	eiver Sensitivity				-23	dBm	3
Rec	eiver Overload		-3			dBm	3
L	LOS De-Assert				-24	dBm	
LOS Assert		LOS _A	-30			dBm	
LOS Hysteresis			1		4	dB	
Data Output Swing Differential		Vout	400		1800	mV	4
	LOS	High	2.0		Vcc	V	
	LU3	Low			0.8	V	

Notes:

- 1. The optical power is launched into SMF.
- 2. PECL input, internally AC-coupled and terminated.
- 3. Measured with a PRBS 2^7 -1 test pattern @1250Mbps, BER $\leq 1 \times 10^{-12}$.
- **4.** Internally AC-coupled

Timing and Electrical

Table 4 - Timing and Electrical

Parameter	Symbol	Min	Typical	Max	Unit
Tx Disable Negate Time	t_on			1	ms
Tx Disable Assert Time	t_off			10	μs
Time To Initialize, including Reset of Tx Fault	t_init			300	ms
Tx Fault Assert Time	t_fault			100	μs



Tx Disable To Reset	t_reset	10		μs
LOS Assert Time	t_loss_on		100	μs
LOS De-assert Time	t_loss_off		100	μs
Serial ID Clock Rate	f_serial_clock		400	KHz
MOD_DEF (0:2)-High	V _H	2	Vcc	V
MOD_DEF (0:2)-Low	V _L		0.8	V

Diagnostics

Table 5 – Diagnostics Specification

Parameter	Range	Unit	Accuracy	Calibration
Temperature	0 to +70 -40 to +85	°C	±3°C	Internal / External
Voltage	3.0 to 3.6	V	±3%	Internal / External
Bias Current	0 to 100	mA	±10%	Internal / External
TX Power	-9 to -3	dBm	±3dB	Internal / External
RX Power	-23 to -3	dBm	±3dB	Internal / External

Digital Diagnostic Memory Map

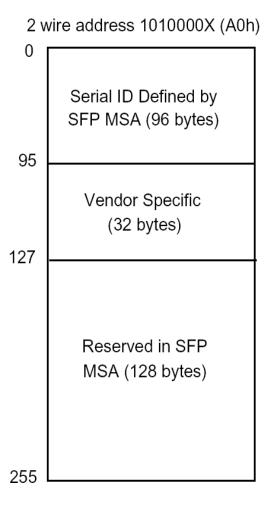
The transceivers provide serial ID memory contents and diagnostic information about the present operating conditions by the 2-wire serial interface (SCL, SDA).

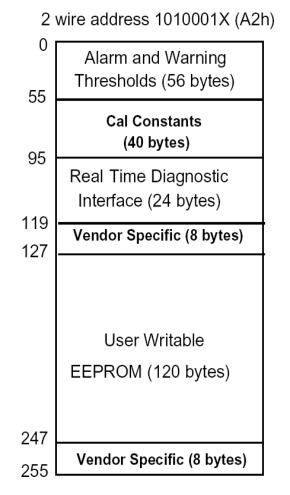
The diagnostic information with internal calibration or external calibration all are implemented, including received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring.

The digital diagnostic memory map specific data field defines as following.













Pin Definitions

Pin Diagram

20 VeeT	1 VeeT
19 TD-	2 TxFault
18 TD+	3 Tx Disable
17 VeeT	4 MOD-DEF(2)
16 VccT	5 MOD-DEF(1)
15 VccR	6 MOD-DEF(0)
14 VeeR	7 Rate Select
13 RD+	8 LOS
12 RD-	9 VeeR
11 VeeR	10 VeeR
Top of Board	Bottom of Board (as viewed thru top of board)



Pin Descriptions

	criptions			
Pin	Signal Name	Description	Plug Seq.	Notes
1	V_{EET}	Transmitter Ground	1	
2	TX FAULT	Transmitter Fault Indication	3	Note 1
3	TX DISABLE	Transmitter Disable	3	Note 2
4	MOD_DEF(2)	SDA Serial Data Signal	3	Note 3
5	MOD_DEF(1)	SCL Serial Clock Signal	3	Note 3
6	MOD_DEF(0)	TTL Low	3	Note 3
7	Rate Select	Not Connected	3	
8	LOS	Loss of Signal	3	Note 4
9	V_{EER}	Receiver ground	1	
10	V_{EER}	Receiver ground	1	
11	V_{EER}	Receiver ground	1	
12	RD-	Inv. Received Data Out	3	Note 5
13	RD+	Received Data Out	3	Note 5
14	V_{EER}	Receiver ground	1	
15	V_{CCR}	Receiver Power Supply	2	
16	V _{CCT}	Transmitter Power Supply	2	
17	V_{EET}	Transmitter Ground	1	
18	TD+	Transmit Data In	3	Note 6
19	TD-	Inv. Transmit Data In	3	Note 6
20	V_{EET}	Transmitter Ground	1	

Notes:

Plug Seq.: Pin engagement sequence during hot plugging.

- 1) TX Fault is an open collector output, which should be pulled up with a $4.7k^{\sim}10k\Omega$ resistor on the host board to a voltage between 2.0V and Vcc+0.3V. Logic 0 indicates normal operation; Logic 1 indicates a laser fault of some kind. In the low state, the output will be pulled to less than 0.8V.
- 2) TX Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a $4.7k^{\sim}10k\Omega$ resistor. Its states are:

Low (0 to 0.8V): Transmitter on (>0.8V, < 2.0V): Undefined

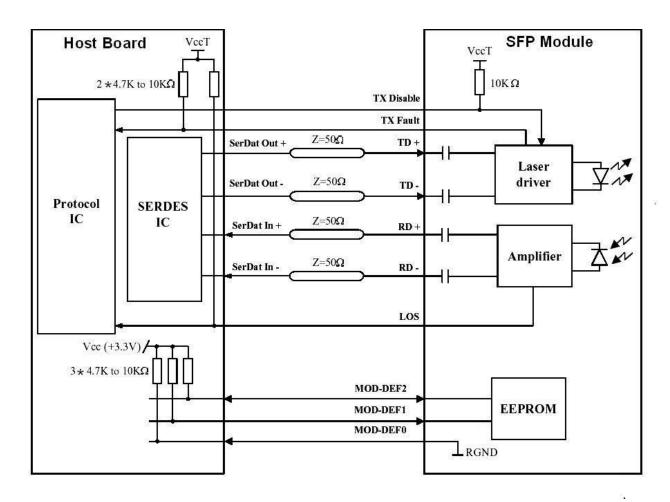
High (2.0 to 3.465V): Transmitter Disabled

Open: Transmitter Disabled



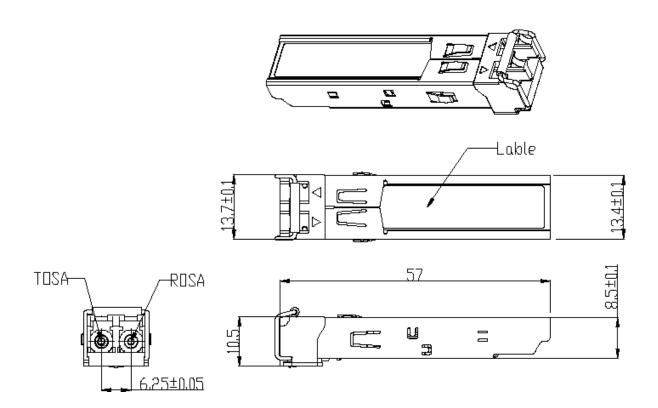
- 3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a $4.7k^{\sim}10k\Omega$ resistor on the host board. The pull-up voltage shall be VccT or VccR.
 - Mod-Def 0 is grounded by the module to indicate that the module is present
 - Mod-Def 1 is the clock line of two wire serial interface for serial ID
 - Mod-Def 2 is the data line of two wire serial interface for serial ID
- 4) LOS is an open collector output, which should be pulled up with a $4.7k^{\sim}10k\Omega$ resistor. Pull up voltage between 2.0V and Vcc+0.3V. Logic 1 indicates loss of signal; Logic 0 indicates normal operation. In the low state, the output will be pulled to less than 0.8V.
- 5) RD-/+: These are the differential receiver outputs. They are internally AC-coupled 100 differential lines which should be terminated with 100Ω (differential) at the user SERDES.
- 6) TD-/+: These are the differential transmitter inputs. They are internally AC-coupled, differential lines with 100Ω differential termination inside the module.

Recommended Interface Circuit





Mechanical Dimensions:



Ordering information

Part Number	Product Description
AGM732F-COM	1310nm, 1.25Gbps, 20km, 0ºC ~ +70ºC